APPLICAE	BLE STAND	DARD									
OPERATING TEMPERATUR		F RANGE	-55 °C TO 85 °	°C (1)		TORAGE EMPERATURE RANGE		iF	-10 °C TO 60 °C	C (2)	
RATING	VOLTAGE		50.74.40		OPE	DPERATING HUMIDITY RANGE			95 % RH MAX.		
						IGE	GE				
	CURRENT		0.3 A (NO DEW CONDENSATION IS PE							:RMIIII	ED)
IT			TEST METHOD		HON	15	DE	- O L II	DEMENTS	ОТ	AT
ITEM CONSTRUCTION		TEST WETHOD				REQUIREMENTS				QI	IA1
	XAMINATION	VISUALI	Y AND BY MEASURING I	NSTRUM	ENT.	ACCOF	RDING T	O DR	AWING.	×	×
MARKING		CONFIRMED VISUALLY.								×	×
ELECTRIC CHARACT											
CONTACT RESISTANCE		,				70 mΩ MAX.				×	-
INSULATION RESISTANCES		100 V DC				100 MΩ MIN.				×	-
VOLTAGE PROOF		150 V AC FOR 1 min.				NO FLASHOVER OR BREAKDOWN.				×	×
MECHANICAL CHAR											
INSERTION AND		MEASURED BY APPLICABLE CONNECTOR.					INSERTION FORCE: 108 N MAX.				-
WITHDRAWAL FORCE MECHANICAL		50 TIMES INSERTIONS AND EXTRACTIONS.				WITHDRAWAL FORCE: 7.2 N MIN.  ① CONTACT RESISTANCE: 80 mΩ MAX.				×	-
OPERATION		30 TIMES INSERTIONS AND EXTINATIONS.				© NO DAMAGE, CRACK AND LOOSENESS OF PARTS.					
VIBRATION		FREQUENCY 10 TO 55 Hz,				NO ELECTRICAL DISCONTINUITY OF				×	-
		SINGLE AMPLITUDE: 0.75 mm, AT 10 CYCLES FOR 3 DIRECTIONS.				1 μs MIN.					
		490 m/s <sup>2</sup> , DURATION OF PULSE 11 ms				OF PARTS.				×	+-
		AT 3 TIMES FOR 3 DIRECTIONS.				3. 17 11.13.					
	MENTAL C										
DAMP HEAT (STEADY STATE)		EXPOSED AT $40\pm2$ °C, 90 $\sim$ 95 %, 96 h.				① CONTACT RESISTANCE: 80 mΩ MAX. ② INSULATION RESISTANCE:100 MΩ MIN.				×	-
RAPID CHANGE OF		TEMPERATURE -55→+15~+35→+85→+15~+35°C				+ -			ACK AND LOOSENESS	×	-
TEMPERATURE		TIME $30 \rightarrow 2 \sim 3 \rightarrow 30 \rightarrow 2 \sim 3$ min. UNDER 5 CYCLES.				OF PARTS.					
DRY HEAT		EXPOSED AT 85 °C , 96 h.				① CONTACT RESISTANCE: 80 mΩ MAX.				×	_
COLD		EXPOSED AT - 55 °C , 96 h.				© NO DAMAGE, CRACK AND LOOSENESS OF PARTS.				×	-
CORROSION SALT MIST		EXPOSED IN 5 % SALT WATER SPRAY FOR 48 h.				NO HEAVY CORROSION.				×	-
SULPHUR DIOXIDE		EXPOSED IN 10 PPM FOR 96 h. (TEST STANDARD: JIS C 0090)				<ul><li>① CONTACT RESISTANCE: 80 mΩ MAX.</li><li>② NO HEAVY CORROSION.</li></ul>				×	-
RESISTANCE TO		1) REFLOW SOLDERING : 250 °C MAX,				NO DEFORMATION OF CASE OF				×	-
SOLDERING HEAT		: 220 °C MIN, FOR 60 s				EXCESSIVE LOOSENESS OF THE TERMINAL.					
		2) SOLDERING IRONS : 360 °C,				TERMINAL.				×	-
		FOR 5 s									
SOLDERABILITY		SOLDERED AT SOLDER TEMPERATURE, 240 ± 3°C, FOR IMMERSION DURATION, 3 s.				A NEW UNIFORM COATING OF SOLDER SHALL OVER A MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.				×	_
				<u>- •                                     </u>							
COUN	T DE	SCRIPTION	ON OF REVISIONS		DESIG	NED			CHECKED		TE
<u>A</u>	<u> </u>							1			
			RISE INCLUDED WHEN ENERGIZED. NDICATES A LONG-TERM STORAGE STATE			APPROVED			HS.OKAWA		2.20
		SED PRODUCT BEFORE THE BOARD MOUNTED.			DESIGNED			HS.OZAWA	06.02.20		
Unless otherwise specified			refer to JIS C 5402			DESIGNED			KY.NAKAMURA	06.02.20	
Note QT:Qualification Test AT:Ass						RAWING NO.		VIV.	KY.NAKAMURA   06.02.		ız.ZU
		PECIFICATION SHEET				PART NO.		FX11A-120P/12-SV0.5(			
			ESTRIC SOLUTE			DE NO. CL57			3-0605-2-71		1/1
FORM HD0011-			•			•			= · · · L		